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	1	TALWAT et al., "Study of Thermal Processing (LTP) to Meet Sub 130 nm Node Shallow Junction Requirements", 2002, pages 175-177					
	2	ITO et al., "Flash Lamp Annealing Technology for Ultra-shallow Junction Formation", Extended Abstracts of International Workshop on Junction Technology, 2002, pages 23-26					
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Yamamoto et al., "Impact of Pre-Amorphization for the Reduction of Contact Resistance Using Laser Thermal

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Process, Extended Abstracts of International Workshop on Junction Technology, 2002, pages 27-30

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